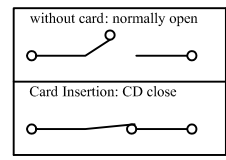
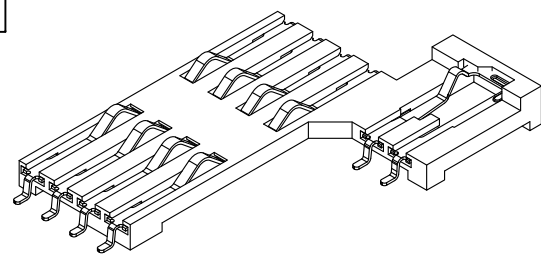
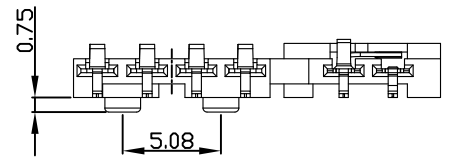


BOARD PAD NO WIRING AREA
 Unit: mm; Tolerances: 0.05 mm
 Reference dimension for PCB layout



Notes:
 Housing: Thermoplastic UL 94V-0
 Contact: Selective Gold Flash
Specifications:
 Voltage Current rating: 1A. 50V AC
 Insulation Resistance: 1000Mohm Min
 Contact Withstanding Voltage:
 AC 500V For 1 Minute
 Temperteur Rating: -40° To +85°

Part number: XNT-MSC-605-08130

— 130: H=1.30mm;A=2.20mm, B=0.60mm
— 155: H=1.55mm;A=2.45mm,B=0.60mm
— 200: H=2.00mm;A=2.90mm;B=0.75mm

REVISION NO.	ECR NO.	DESCRIPTION	MARK	DATE
1				
2				
3				

	深圳市鑫南天科技有限公司 Shenzhen XinNanTian Technology Co., Ltd				
	DIMENSIONS INIT: mm UNLESS OTHERWISE SPECIFIABLE	PRODUCT NAME : mini Smart card connector	DRAWING: COCO	DATE: 2014/01/15	
	DIMENSION TOLERANCE X.X: ± 0.38 X.XX: ± 0.25 X.XXX: ± 0.10 ANGULAR: ± 1°	PRODUCT NO. : XNT-MSC-605-08130	CHECK: AG	DATE: 2014/01/15	
		DRAWING NO. : XNT-MSC-605-08130	APPROVED: JEFF	DATE: 2014/01/15	
		SCALE: NA	DWG ID: P D	REV.: A	PAGE: 1 OF 1